| L Number | Hits | Search Text | DB | Time Stamp |
|---|---|---|---|---|
| 1 | 4518 | ((438/464,716,618) or (118/64,666,667,500)).CCLS. | USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB | 2003/03/28 14:47 |
| 2 | 370 | (((438/464,716,618) or (118/64,666,667,500)).CCLS.) and temperature near5 control | USPAT | 2003/03/28 14:33 |
| 3 | 169 | ((((438/464,716,618) or (118/64,666,667,500)).CCLS.) and temperature near5 control) and detect$3 | USPAT | 2003/03/28 14:43 |
| 4 | 121 | (((((438/464,716,618) or (118/64,666,667,500)).CCLS.) and temperature near5 control) and detect$3) and (semiconductor wafer) | USPAT | 2003/03/28 14:46 |
| 5 | 77 | ((((((438/464,716,618) or (118/64,666,667,500)).CCLS.) and temperature near5 control) and detect$3) and (semiconductor wafer)) and range | USPAT | 2003/03/28 14:47 |
| 6 | 76 | (((((((438/464,716,618) or (118/64,666,667,500)).CCLS.) and temperature near5 control) and detect$3) and (semiconductor wafer)) and range) and heat$3 | USPAT | 2003/03/28 14:47 |